

DATA SHEET

BLW96 **HF/VHF power transistor**

Product specification
File under Discrete Semiconductors, SC08a

August 1986

HF/VHF power transistor

BLW96

DESCRIPTION

N-P-N silicon planar epitaxial transistor intended for use in class-A, AB and B operated high power industrial and military transmitting equipment in the h.f. and v.h.f. band. The transistor presents excellent performance as a linear amplifier in s.s.b. applications. It is resistance stabilized and is guaranteed to withstand severe load mismatch

conditions. Transistors are supplied in matched h_{FE} groups.

The transistor has a $\frac{1}{2}$ " flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

R.F. performance up to $T_h = 25^\circ\text{C}$

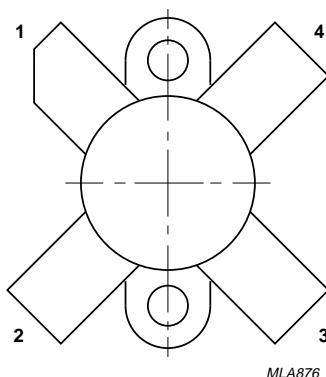
MODE OF OPERATION	V_{CE} V	f MHz	P_L W	G_p dB	η %	d_3 dB	d_5 dB	$I_{C(zs)}$ (I_C) A
s.s.b. (class-AB)	50	1,6 – 28	25 – 200 (P.E.P.)	> 13,5	> 40 ⁽¹⁾	< -30	< -30	0,1
c.w. (class-B)	50	108	200	typ. 6,5	typ. 67	–	–	(6)
s.s.b. (class-A)	40	28	50 (P.E.P.)	typ. 19	–	typ. -40	< -40	(4)

Note

- η_{dt} at 200 W P.E.P.

PIN CONFIGURATION

PINNING - SOT121B.



PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter

Fig.1 Simplified outline. SOT121B.

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

HF/VHF power transistor

BLW96

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage ($V_{BE} = 0$)

peak value

 V_{CESM} max. 110 V

Collector-emitter voltage (open base)

 V_{CEO} max. 55 V

Emitter-base voltage (open collector)

 V_{EBO} max. 4 V

Collector current (average)

 $I_{C(AV)}$ max. 12 ACollector current (peak value); $f > 1$ MHz I_{CM} max. 40 AR.F. power dissipation ($f > 1$ MHz); $T_{mb} = 45$ °C P_{rf} max. 340 W

Storage temperature

 T_{stg} -65 to +150 °C

Operating junction temperature

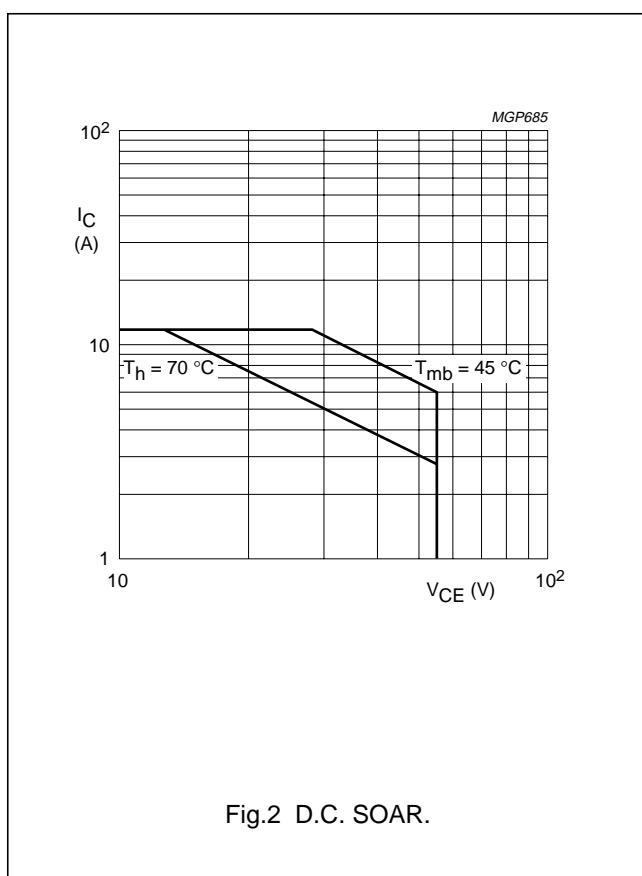
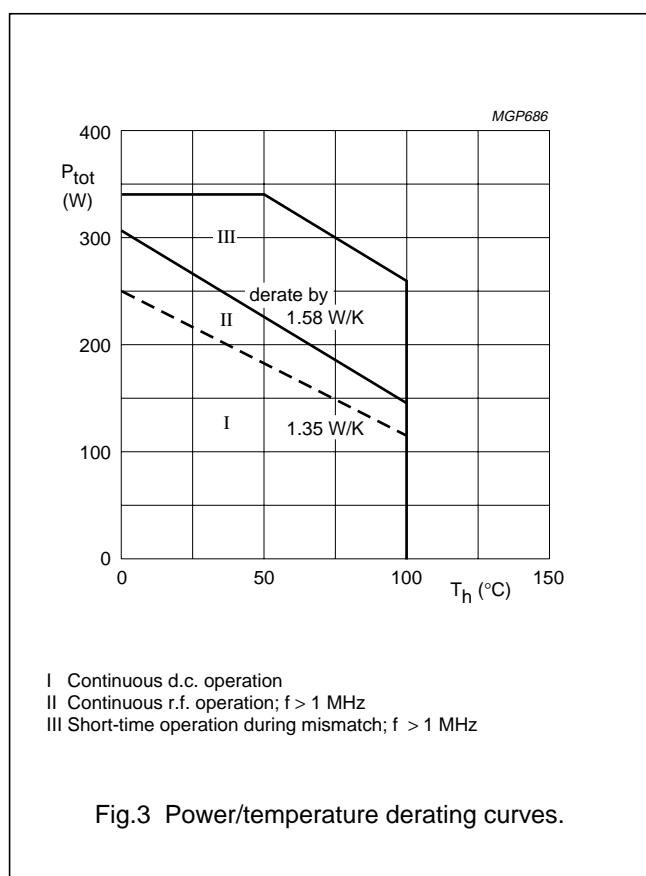
 T_j max. 200 °C

Fig.2 D.C. SOAR.



- I Continuous d.c. operation
- II Continuous r.f. operation; $f > 1$ MHz
- III Short-time operation during mismatch; $f > 1$ MHz

Fig.3 Power/temperature derating curves.

THERMAL RESISTANCE

(dissipation = 150 W; $T_{mb} = 100$ °C, i.e. $T_h = 70$ °C)

From junction to mounting base (d.c. dissipation)

 $R_{th j-mb(dc)}$ = 0,63 K/W

From junction to mounting base (r.f. dissipation)

 $R_{th j-mb(rf)}$ = 0,45 K/W

From mounting base to heatsink

 $R_{th mb-h}$ = 0,2 K/W

HF/VHF power transistor

BLW96

CHARACTERISTICS

 $T_j = 25^\circ\text{C}$

Collector-emitter breakdown voltage

 $V_{BE} = 0$; $I_C = 50 \text{ mA}$ $V_{(BR)CES}$ > 110 V

Collector-emitter breakdown voltage

open base; $I_C = 200 \text{ mA}$ $V_{(BR)CEO}$ > 55 V

Emitter-base breakdown voltage

open collector; $I_E = 20 \text{ mA}$ $V_{(BR)EBO}$ > 4 V

Collector cut-off current

 $V_{BE} = 0$; $V_{CE} = 55 \text{ V}$ I_{CES} < 10 mASecond breakdown energy; $L = 25 \text{ mH}$; $f = 50 \text{ Hz}$ open base E_{SBO} > 20 mJ $R_{BE} = 10 \Omega$ E_{SBR} > 20 mJD.C. current gain⁽¹⁾ $I_C = 7 \text{ A}$; $V_{CE} = 5 \text{ V}$ h_{FE} typ. 30

15 to 50

D.C. current gain ratio of matched devices⁽¹⁾ $I_C = 7 \text{ A}$; $V_{CE} = 5 \text{ V}$ h_{FE1}/h_{FE2} ≤ 1,2Collector-emitter saturation voltage⁽¹⁾ $I_C = 20 \text{ A}$; $I_B = 4 \text{ A}$ V_{CEsat} typ. 1,9 VTransition frequency at $f = 100 \text{ MHz}$ ⁽²⁾ $-I_E = 7 \text{ A}$; $V_{CB} = 45 \text{ V}$ f_T typ. 235 MHz $-I_E = 20 \text{ A}$; $V_{CB} = 45 \text{ V}$ f_T typ. 245 MHzCollector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0$; $V_{CB} = 50 \text{ V}$ C_c typ. 280 pFFeedback capacitance at $f = 1 \text{ MHz}$ $I_C = 150 \text{ mA}$; $V_{CE} = 50 \text{ V}$ C_{re} typ. 170 pF

Collecting-flange capacitance

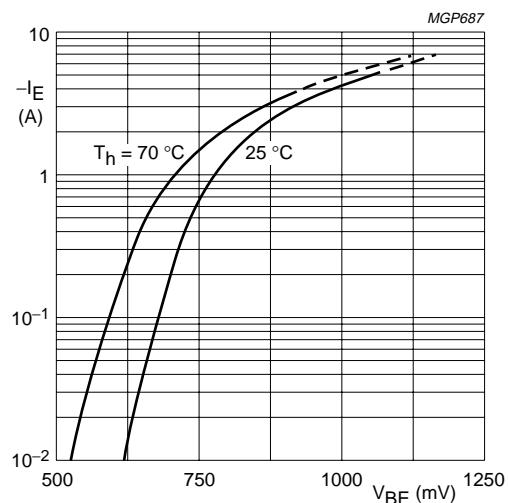
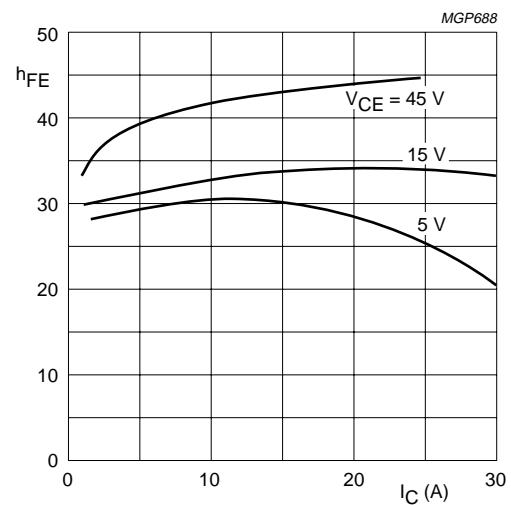
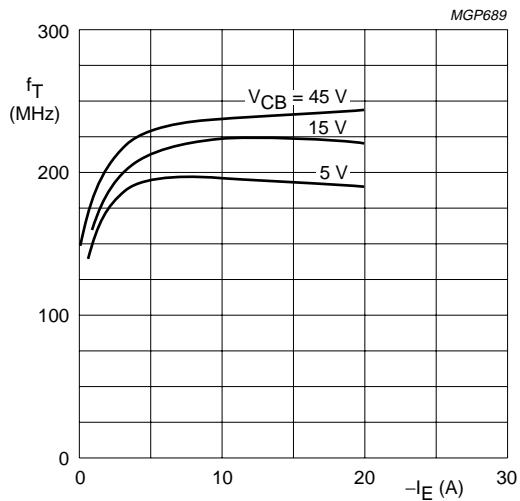
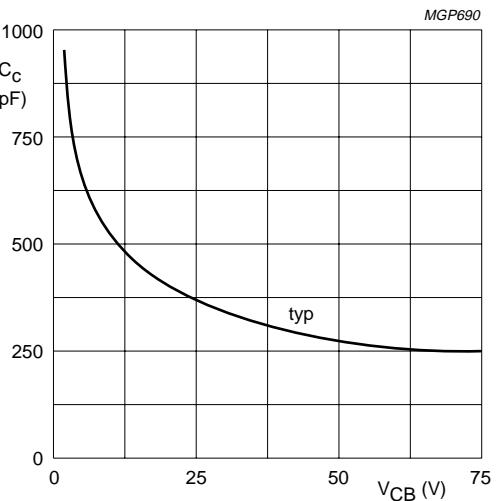
 C_{cf} typ. 4,4 pF

Notes

1. Measured under pulse conditions: $t_p \leq 300 \mu\text{s}$; $\delta \leq 0,02$.
2. Measured under pulse conditions: $t_p \leq 50 \mu\text{s}$; $\delta \leq 0,01$.

HF/VHF power transistor

BLW96

Fig.4 Typical values; $V_{CE} = 40$ V.Fig.5 Typical values; $T_j = 25$ °C.Fig.6 Typical values; $f = 100$ MHz; $T_j = 25$ °C.Fig.7 $I_E = I_e = 0$; $f = 1$ MHz; $T_j = 25$ °C.

HF/VHF power transistor

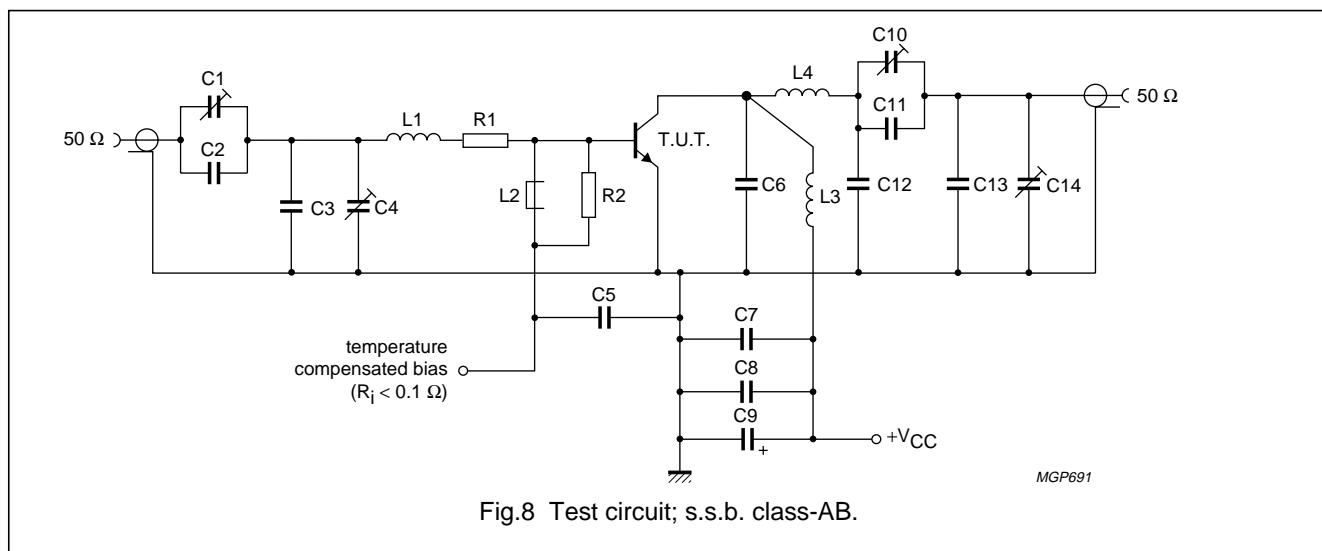
BLW96

APPLICATION INFORMATION

R.F. performance in s.s.b. class-AB operation (linear power amplifier)

$$V_{CE} = 50 \text{ V}; T_h = 25 \text{ }^\circ\text{C}; f_1 = 28,000 \text{ MHz}; f_2 = 28,001 \text{ MHz}$$

OUTPUT POWER W	G _p dB	η _{dt} (%) at 200 W (P.E.P.)	I _C (A)	d ₃ ⁽¹⁾ dB	d ₅ ⁽¹⁾ dB	I _{C(ZS)} A
25 to 200 (P.E.P.)	> 13,5	> 40	< 5,0	< -30	< -30	0,1



List of components:

C1 = C4 = C10 = C14 = 100 pF film dielectric trimmer

C2 = 27 pF ceramic capacitor (500 V)

C3 = 270 pF polysterene capacitor (630 V)

C5 = C7 = C8 = 220 nF multilayer ceramic chip capacitor

C6 = 27 pF multilayer ceramic chip capacitor (500 V; ATC⁽²⁾)

C9 = 47 μ F/63 V electrolytic capacitor

C11 = 2 × 36 pF multilayer ceramic chip capacitors (500 V; ATC⁽²⁾) in parallel

C12 = 2 × 43 pF multilayer ceramic chip capacitors (500 V; ATC⁽²⁾) in parallel

C13 = 43 pF multilayer ceramic chip capacitor (500 V; ATC⁽²⁾)

L1 = 88 nH; 3 turns Cu wire (1.0 mm); int. dia. 9.0 mm; length 6.1 mm; leads 2 x 5 mm

L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L3 = 150 nH; 5 turns Cu wire (2.0 mm); int. dia. 10.0 mm; length 18.7 mm; leads 2 × 5 mm

1.4 = 197 nH; 5 turns Cu wire (2.0 mm); int. dia. 12.0 mm; length 18.6 mm; leads 2 × 5 mm

R1 = 0.66 Ω; parallel connection of $5 \times 3.3\Omega$ metal film resistors (PR37; $\pm 5\%$; 1.6 W each)

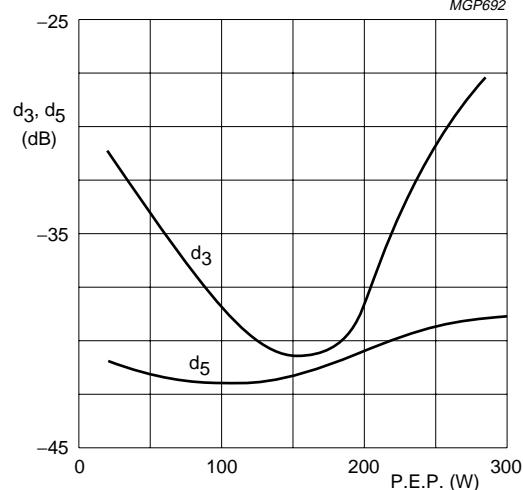
R2 = 27 Ω carbon resistor ($\pm 5\%$; 0.5 W)

Notes

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplitude tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.
2. ATC means American Technical Ceramics.

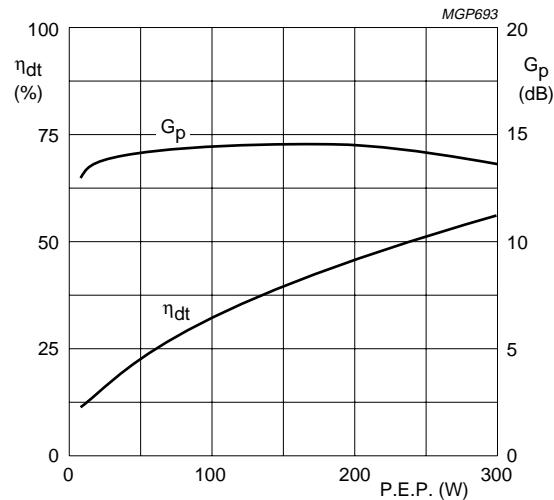
HF/VHF power transistor

BLW96



$V_{CE} = 50$ V; $I_{C(ZS)} = 0,1$ A; $f_1 = 28,000$ MHz;
 $f_2 = 28,001$ MHz; $T_h = 25$ °C; typical values.

Fig.9 Intermodulation distortion as a function of output power.⁽¹⁾



$V_{CE} = 50$ V; $I_{C(ZS)} = 0,1$ A; $f_1 = 28,000$ MHz;
 $f_2 = 28,001$ MHz; $T_h = 25$ °C; typical values.

Fig.10 Double-tone efficiency and power gain as a function of output power.

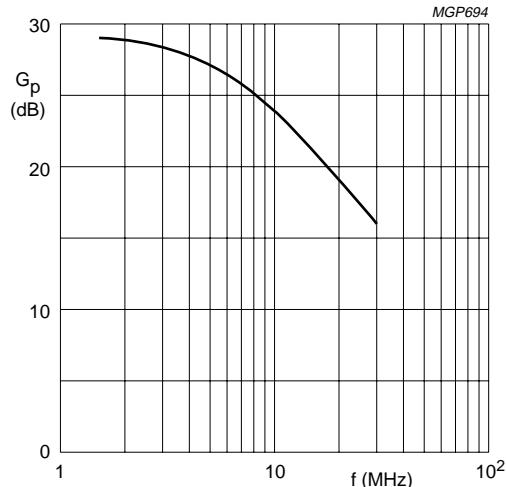
Ruggedness

The BLW96 is capable of withstanding full load mismatch (VSWR = 50 through all phases) up to 150 W (P.E.P.) or a load mismatch (VSWR = 5 through all phases) up to 200 W (P.E.P.) under the following conditions:

$V_{CE} = 45$ V; $f = 28$ MHz; $T_h = 70$ °C; $R_{th\ mb-h} = 0,2$ K/W.

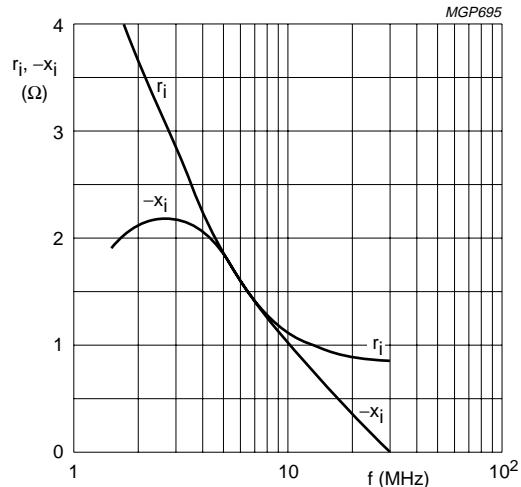
HF/VHF power transistor

BLW96



$V_{CE} = 50$ V; $I_{C(ZS)} = 0,1$ A; $P_L = 200$ W (P.E.P.);
 $T_h = 25$ °C; $Z_L = 5$ Ω; neutralizing capacitor: 47 pF

Fig.11 Power gain as a function of frequency.



$V_{CE} = 50$ V; $I_{C(ZS)} = 0,1$ A; $P_L = 200$ W (P.E.P.);
 $T_h = 25$ °C; $Z_L = 5$ Ω; neutralizing capacitor: 47 pF

Fig.12 Input impedance (series components) as a function of frequency.

Figs 11 and 12 are typical curves and hold for one transistor of a push-pull amplifier with cross-neutralization in s.s.b. class-AB operation.

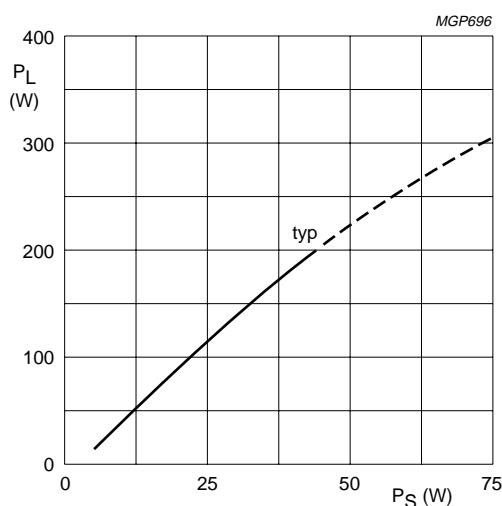
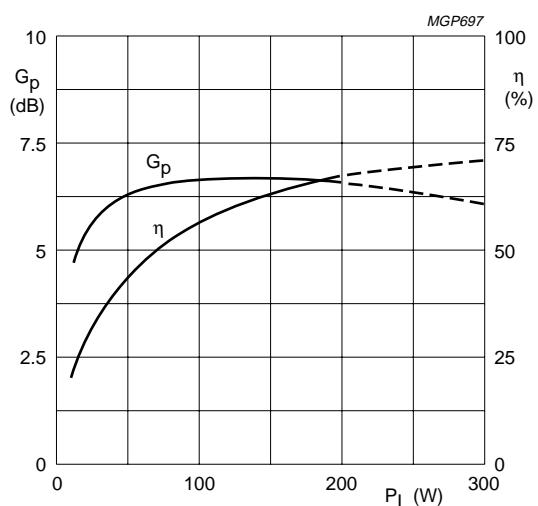
HF/VHF power transistor

BLW96

R.F. performance in c.w. operation (unneutralized common-emitter class-B circuit)

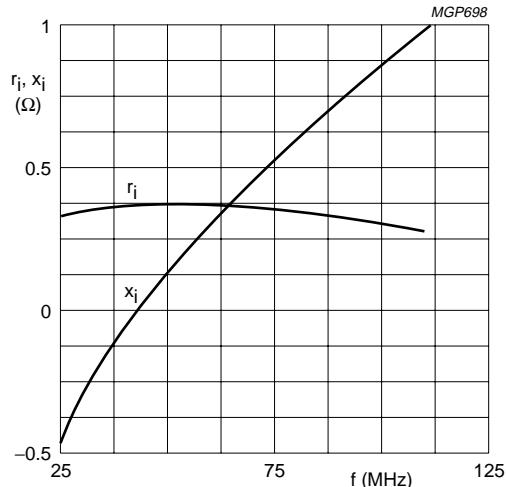
 $T_h = 25^\circ\text{C}$

f (MHz)	V_{CE} (V)	P_L (W)	P_s (W)	G_p (dB)	I_c (A)	η (%)
108	50	200	typ. 45	typ. 6,5	typ. 6	typ. 67

Fig.13 $V_{CE} = 50$ V; $f = 108$ MHz; $T_h = 25^\circ\text{C}$.Fig.14 $V_{CE} = 50$ V; $f = 108$ MHz; $T_h = 25^\circ\text{C}$; typical values.

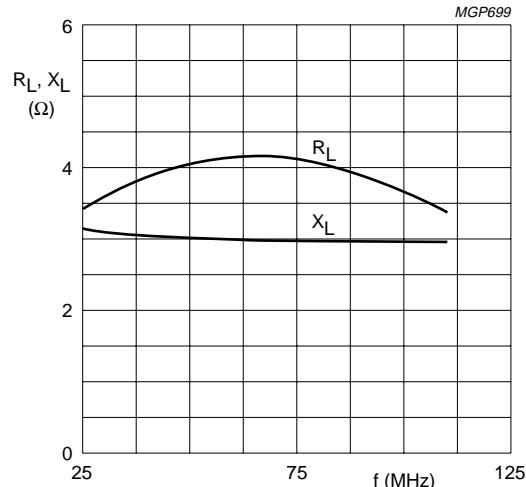
HF/VHF power transistor

BLW96



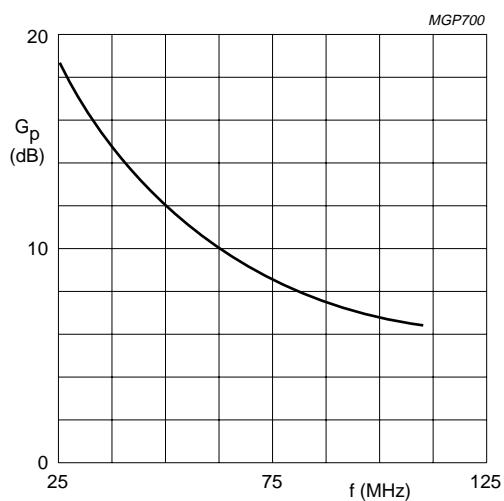
Typical values; $V_{CE} = 50$ V; $P_L = 200$ W; $T_h = 25$ °C;
class-B operation

Fig.15 Input impedance (series components).



Typical values; $V_{CE} = 50$ V; $P_L = 200$ W; $T_h = 25$ °C;
class-B operation

Fig.16 Load impedance (series components).



Typical values; $V_{CE} = 50$ V; $P_L = 200$ W; $T_h = 25$ °C;
class-B operation

Fig.17

HF/VHF power transistor

BLW96

R.F. performance in s.s.b. class-A operation (linear power amplifier)

 $V_{CE} = 40$ V; $T_h = 25$ °C; $f_1 = 28,000$ MHz; $f_2 = 28,001$ MHz

OUTPUT POWER W	G_p dB	I_C A	$d_3^{(1)}$ dB	$d_5^{(1)}$ dB
typ. 50 (P.E.P.)	typ. 19	4	typ. -40	< -40

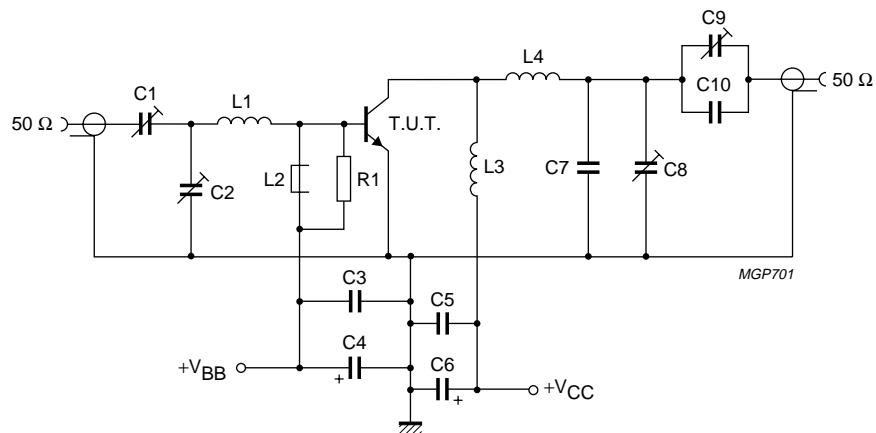


Fig.18 Test circuit; s.s.b. class-A.

List of components:

C1 = C2 = 10 to 780 pF film dielectric trimmer

C3 = 220 nF polyester capacitor (100 V)

C4 = 100 µF/4 V electrolytic capacitor

C5 = 2 × 330 nF polyester capacitors (100 V) in parallel

C6 = 47 µF/63 V electrolytic capacitor

C7 = C10 = 2 × 82 pF ceramic capacitors (500 V) in parallel

C8 = C9 = 10 to 150 pF air dielectric trimmer

L1 = 45 nH; 2 turns enamelled Cu wire (1,6 mm); int. dia. 8,0 mm; length 4,0 mm; leads 2 × 3 mm

L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L3 = 110 nH; 4 turns enamelled Cu wire (2,0 mm); int. dia. 10,0 mm; length 8,0 mm; leads 2 × 2 mm

L4 = 210 nH; 5 turns enamelled Cu wire (2,0 mm); int. dia. 12,0 mm; length 10,0 mm; leads 2 × 2 mm

R1 = 27 Ω carbon resistor (± 5%; 0,5 W)

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.

HF/VHF power transistor

BLW96

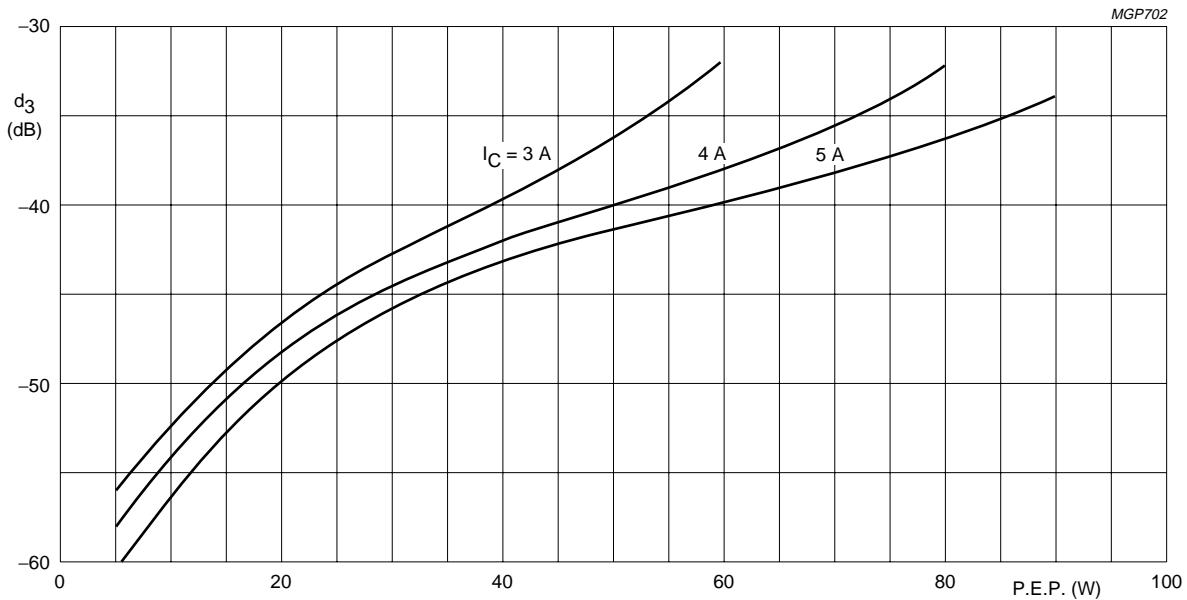


Fig.19 Third order intermodulation distortion as a function of output power.⁽¹⁾ Typical values; $V_{CE} = 40$ V; $T_h = 25$ °C; $f_1 = 28,000$ MHz; $f_2 = 28,001$ MHz.

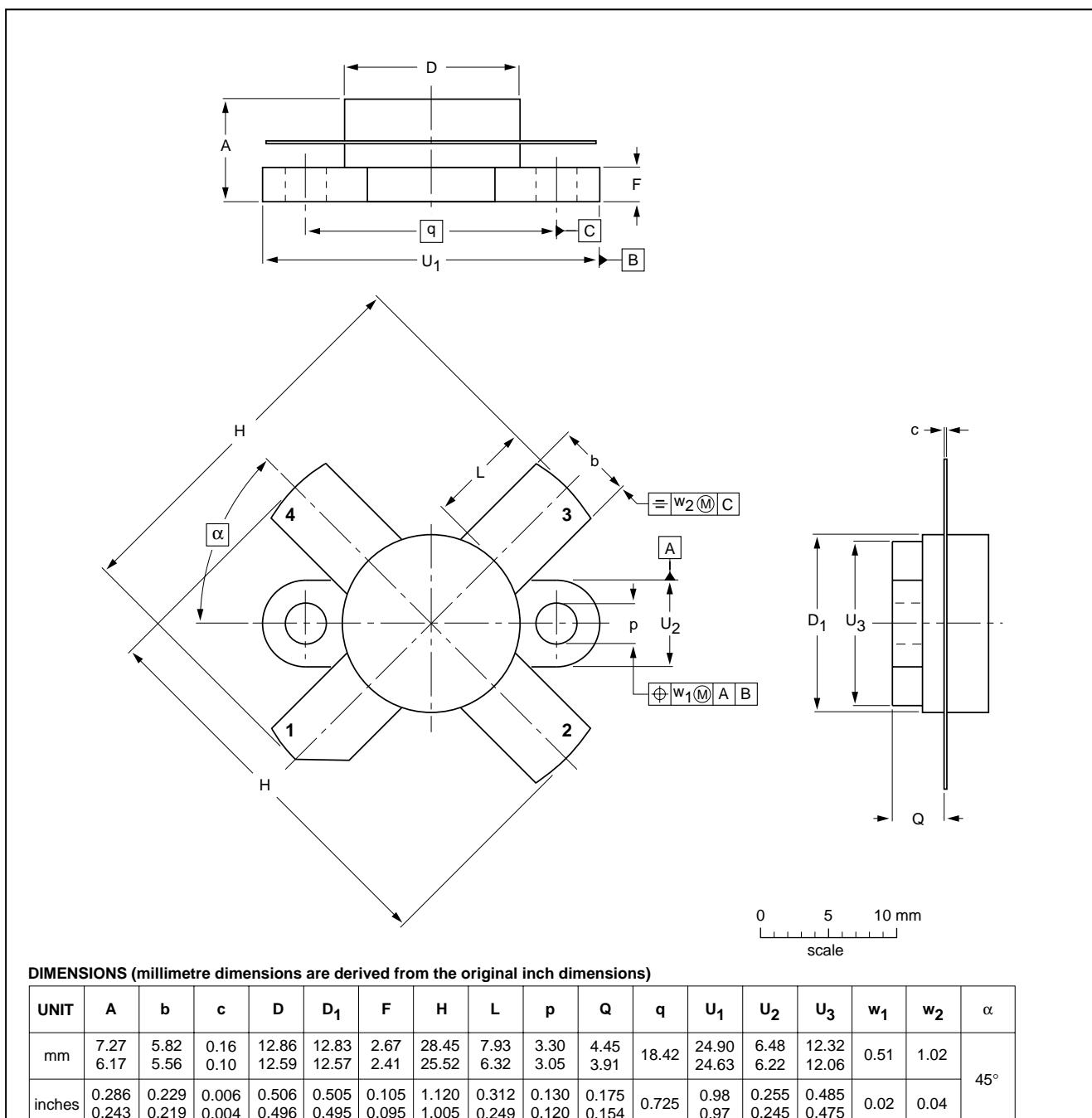
HF/VHF power transistor

BLW96

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT121B



OUTLINE VERSION	REFERENCES					EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ				
SOT121B							97-06-28

HF/VHF power transistor

BLW96

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.